# 502649683 01/24/2014

### PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2696291

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
ATSUHIRO SAITO	01/15/2014

#### **RECEIVING PARTY DATA**

Name:	YAZAKI CORPORATION
Street Address:	4-28, MITA 1-CHOME, MINATO-KU
City:	ТОКҮО
State/Country:	JAPAN
Postal Code:	108-8333

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14163029

## **CORRESPONDENCE DATA**

Fax Number: (202)739-3001 Phone: 2027393000

Email: patents@morganlewis.com, kcasavecchia@morganlewis.com

Correspondence will be sent via US Mail when the email attempt is unsuccessful.

Correspondent Name: ROBERT J. GAYBRICK

Address Line 1: 1111 PENNSYLVANIA AVENUE NW

Address Line 4: WASHINGTON, DISTRICT OF COLUMBIA 20004

ATTORNEY DOCKET NUMBER:	40894-7887
NAME OF SUBMITTER:	MARY JANE BOSWELL
Signature:	/Mary Jane Boswell/
Date:	01/24/2014

**Total Attachments: 1** 

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PATENT REEL: 032038 FRAME: 0704

### **ASSIGNMENT**

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

for which I/WE executed an application for United States Letters Patent concurrently herewith; or

filed an application for United States Letters Patent on \_\_\_\_\_\_, (Application

RECORDED: 01/24/2014

# RECEPTACLE CONNECTOR

, and		
WHEREAS, YAZAKI CORPORAT address is 4-28, Mita 1-chome, Minato-k to as Assignee), is desirous of securing the entire application for United States Letters Patent on tapplication;	re right, title, and interest in and to this i	nafter referred nvention, the
NOW THEREFORE, be it known that, which from assignee is hereby acknowledged, I and set over, and do hereby sell, assign, transfer and assigns, MY/OUR entire right, title, and int all divisions, and continuations thereof, and all granted thereon, and all reissues thereof; and I/V Patents and Trademarks of the United States to its successors and assigns, in accordance with the	r, and set over unto the assignee, its law the terest in and to this invention and this application. Letters Patent of the United States which WE hereby authorize and request the Coissue all Letters Patent for this invention.	, transferred, ful successors plication, and may be mmissioner of
AND, I/WE HEREBY further covenant consideration, communicate with assignee, its strespecting this invention and testify in any legal to do so, execute and deliver all papers that may invention in said assignee, its successors and as applications, make all rightful oaths and general successors and assigns, to obtain and enforce processors, it being understood that any expense incommunication that assignee, its successors and assigns.	I proceeding, sign all lawful papers when y be necessary or desirable to perfect the signs, execute all divisional, continuatio Ily do everything possible to aid assigne roper patent protection for this invention	to ME/US n called upon title to this n, and reissue e, its in the United
Declaration and Power of Attorney in this appli	quest the attorneys I/WE have empower cation, to insert here in parenthesis (Appropriate and application number of said a	olication No.
IN TESTIMONY WHEREOF, I/WE ha	ave hereunto set our hand(s).	
Full Name of Sole or First Assignor Atsuhito SAITO	Assignor's Signature  Atsukito SAITO	Date January 15,2014
Address c/o Yazaki Parts Co., Ltd., 1500, Mishuk	u, Susono-shi, Shizuoka, Japan	Citizenship Japan
Full Name of Second Assignor Koji HAYASHI	Assignor's Signature	Date
Address c/o Yazaki Syscomplus Co., Ltd., 3154, N Kanagawa, Japan	Jagatsutacho, Midori-ku, Yokohama-shi,	Citizenship Japan
Names of additional inventors attached Yes	⊠ No	

PATENT REEL: 032038 FRAME: 0705